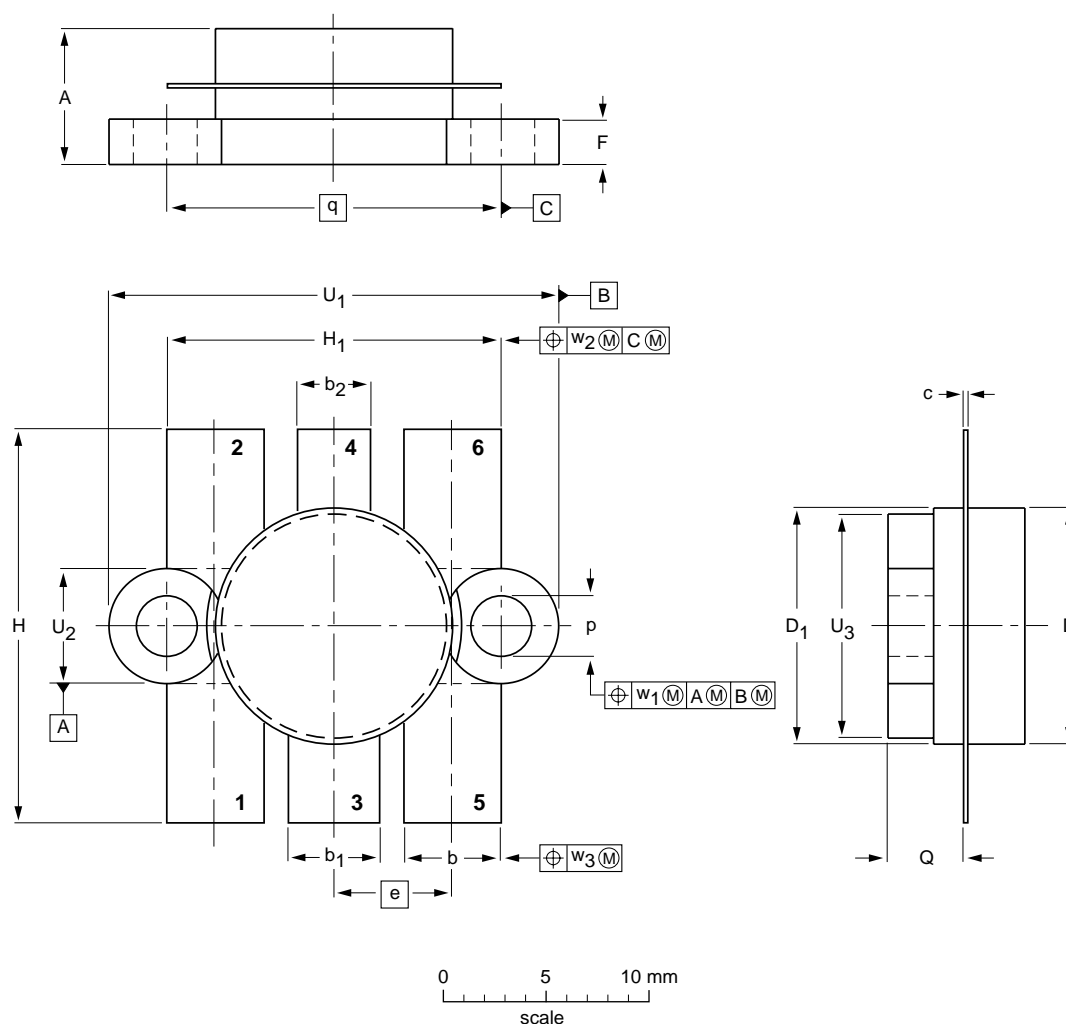


## Philips Semiconductors

## Package outline

Flanged ceramic package; 2 mounting holes; 6 leads

SOT119A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	b <sub>1</sub>	b <sub>2</sub>	c	D	D <sub>1</sub>	e	F	H	H <sub>1</sub>	p	Q	q	U <sub>1</sub>	U <sub>2</sub>	U <sub>3</sub>	w <sub>1</sub>	w <sub>2</sub>	w <sub>3</sub>
mm	7.39 6.32	5.59 5.33	5.34 5.08	4.07 3.81	0.15 0.10	12.86 12.59	12.83 12.57	6.48	2.54 2.29	21.97 21.21	18.55 18.28	3.30 3.05	4.57 4.06	18.42	24.89 24.64	6.48 6.22	12.32 12.07	0.25	0.51	0.25
inches	0.291 0.249	0.220 0.210	0.210 0.200	0.160 0.150	0.006 0.004	0.505 0.496	0.505 0.495	0.255	0.100 0.090	0.865 0.835	0.730 0.720	0.130 0.120	0.180 0.160	0.725	0.980 0.970	0.255 0.245	0.485 0.475	0.010	0.020	0.010

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT119A						99-03-29